ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	, Bannockburn, Illinoi	s. All rights reserv	tion with lowe	r level	parts, the	declarati	on encomp	asses all lowe	er level mate	erials for w	te: if the item is ar vhich the manufa e this declaration	cturer has			
1752-2 1.1 IPC Web Site for I		C-1752 Standa	ard					claration Class * sss 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat							
Supplier Information															
Company Name * Company Un	Unique ID Authority R			onse Date) *	Re	esponse Doci	ument ID							
IDT				2009-	12-17		BE	EG48							
Contact Name * Title - Contact	t	Phone - Contact *			I - Contac	t *		Duplicate	Contact	> Authori	zod Poprocontat	tivo			
CS Phek Engineer		604-613-253	csph	ek@idt.co	m		Duplicate Contact -> Authorized Representative								
Authorized Representative * Title - Repres	entative	Phone - Representative *			- Repres	entative	ອ * Sເ	Supplier Comments or URL for Additional Information							
CS Phek Engineer		604-613-253	csphek@idt.com												
Requester Item Number Mfr Item Numb	er	Mfr Item Name	e	Effecti	ve Date	Version Man		uring Site	Weight *	UOM	1 Unit Type	е			
		BEG48		2009-	12-17	0	ATP		156.8	mg	Each				
Alternate Recommendation			Alternate Item C			ments									
Manufacturing Process Information															
Terminal Plating / Grid Array Material	Base Alloy	ating	ting Peak Process Body T			ire Max Time	at Peak Temp	perature N	umber of Reflow C	Cycles					
Tin/Silver/Copper (Sn/Ag/Cu) Comments	licable		260			C		30 seconds 3							

Save the fields in this form to a fileExport DataImport fields from a file into this formClear all of the fields on this formReset I	Form Lock the fields on this form to prevent changes Lock Supplier Fields												
RoHS Material Composition Declaration Declaration Simplified													
RoHS Directive 2002/95/ECRoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium													
Supplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Uni Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in s Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensiv written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreemedies for issues that arise regarding information the Supplier provides in this form.	on member state laws that implement the RoHS Directive. Company acknowledges that situations where Supplier has not independently verified information provided by others, e as the certification in this paragraph. If the Company and the Supplier enter into a												
RoHS Declaration * 1 - Item(s) does not contain RoHS restricted substances per the definition above	Supplier Acceptance * Accepted												
Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.													
Declaration Signature													
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.													
Supplier Digital Signature													

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of	Tolerance		PPM
	Name	Material Weight Measu		Measure			Level	Substance Category			Substance	CAS	Lvempt	Weight	Measure	-	+		
+I -I	BEG48	+M -M	Mold Compound	61.48	mg	+C	-C	Supplier	Filler	+S	-s	Fused Silica	60676-86-0		53.49	mg	0.02	0.02	341,12
		_				+C	ċ	Supplier	Binder	+S	-S	Epoxy Resin	Trade Secre		6.76	mg			43,131
						+C	ċ	Supplier	Flame Retardant	+S	-S	Metal Hydroxide	Trade Secre		0.92	mg			5,882
						+C	-C	Supplier	Coloring	+S	-s	Carbon Black	1333-86-4		0.31	mg			1,961
		+M -M	Die Attach Adhe	\$ 4.67	mg	+C	-C	Supplier	Filler	+S	-s	Silver	7440-22-4		3.5	mg			22,350
						+C	-C	Supplier	Binder	+S	-s	Epoxy Resin	Trade Secre		1.17	mg			7,450
		+M -M	Substrate	62.72	mg	+C	-C	Supplier	Conductor	+S	-S	Copper	7440-50-8		23.87	mg			152,24
						+C	-C	Supplier	Non Conductive	+S	-s	Core Material	Trade Secre		24.84	mg			158,44
						+C	ċ	Supplier	Non Conductive	+S	-S	Solder Mask	Trade Secre		9.16	mg			58,440
						+C	ċ	Supplier	Plating	+S	-S	Nickel (Use Internal On	7440-02-00		4.15	mg			26,440
						+C	-C	Supplier	Plating	+S	-s	Gold	7440-57-5		0.7	mg			4,440
		+M -M	Solder Ball	5.28	mg	+C	-C	Supplier	Metal	+S	-S	Tin	7440-31-5		5.1	mg			32,521
						+C	ċ	Supplier	Metal	+S	-S	Silver	7440-22-4		0.16	mg			1,011
						+C	-C	Supplier	Metal	+S	-s	Copper	7440-50-8		0.03	mg			169
		+M -M	Bond Wire	0.63	mg	+C	-C	Supplier	Wire	+S	-s	Gold	7440-57-5		0.63	mg			4,000
		+M -M	Silicon	22.01	mg	+C	-C	Supplier	Silicon Chip	+S	-S	Silicon	7440-21-3		22.01	mg			140,40